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Orderable:	Designed for: Public Release	Mod. Date: 8/24/2017
TID #: TIDA-00638	Project Title: ISO Gate Driver Card	
Number: TIDA-00638	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: TIDA-00638Sch.SchDoc	Size: B
Engineer: Bart Basile	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



PCB Number: TIDA-00638  
PCB Rev: E1

PCB LOGO  
Pb-Free Symbol

PCB LOGO  
FCC disclaimer

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: TIDA-00638	Project Title: ISO Gate Driver Card		
Number: TIDA-00638	Rev: E1	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By:	File: EVM_Hardware.SchDoc	Size: B	
Engineer: Bart Basile	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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